

Investigations of a BiCMOS Pixel Sensor

A close look on its early breakdown

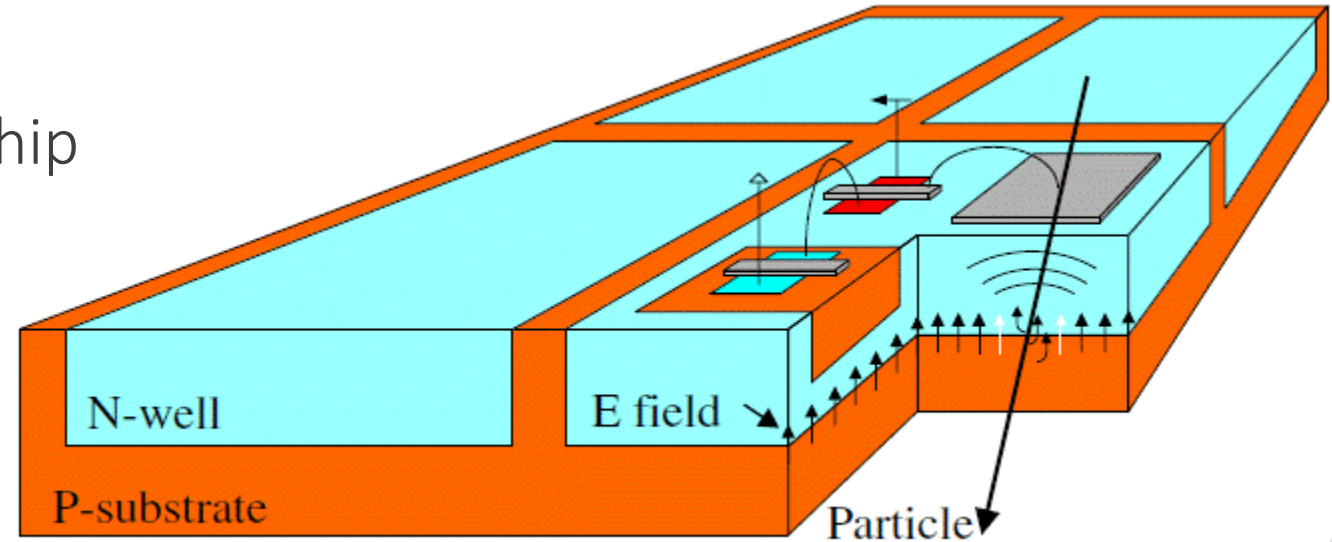
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Verbund Meeting CMOS - 27.02.2023

High Voltage – Monolithic Active Pixel Sensors

- detection and readout on one chip
 - in-pixel electronics
- high voltage:
 - fast charge detection via drift
 - large depletion area
- commercially available processes



I. Peric, P. Fischer et al.:
NIM A 582 (2007) 87

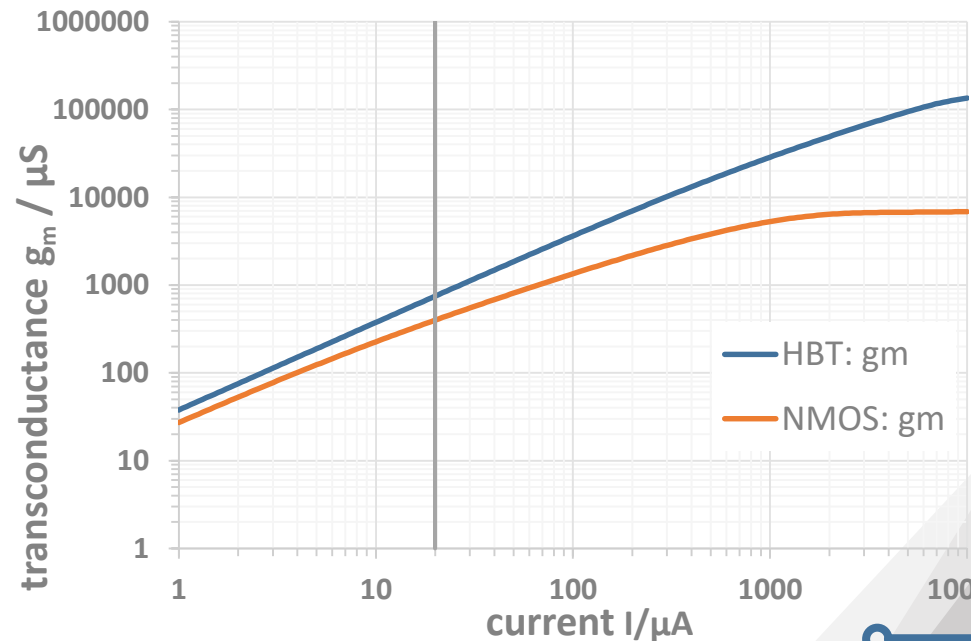
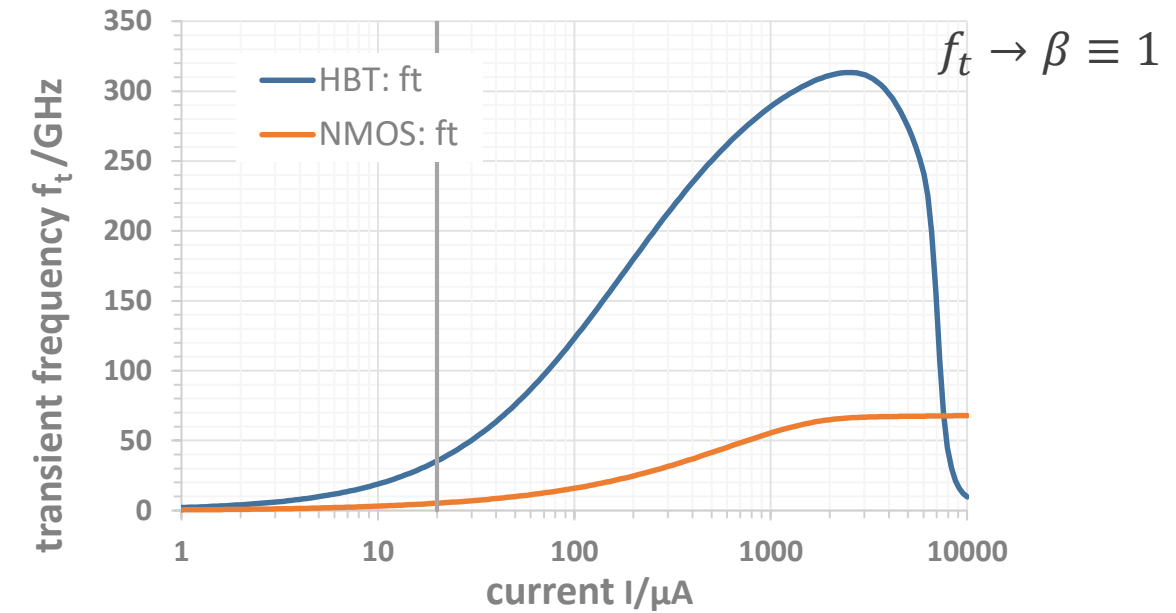
BiCMOS Process

- combines bipolar (HBT) and MOS transistors
 - allows to benefit from CMOS logic
- advantages of bipolar transistors:
 - fast switching times
 - large current gain

} scales with current

Idea:

- build HV-MAPS in a BiCMOS process
- use single HBT to boost the performance of the in-pixel amplifier
- achieve very good time resolution



Existing Projects

University of Geneva:

🔗 general R&D chip: G. Iacobucci et al., doi: 10.1088/1748-0221/17/02/P02019

- 🔗 hexagonal pixels with $65\mu m$ side

- 🔗 time resolution of $\sigma_t \approx 80 ps$ ($I_{preamp} = 20\mu A$)

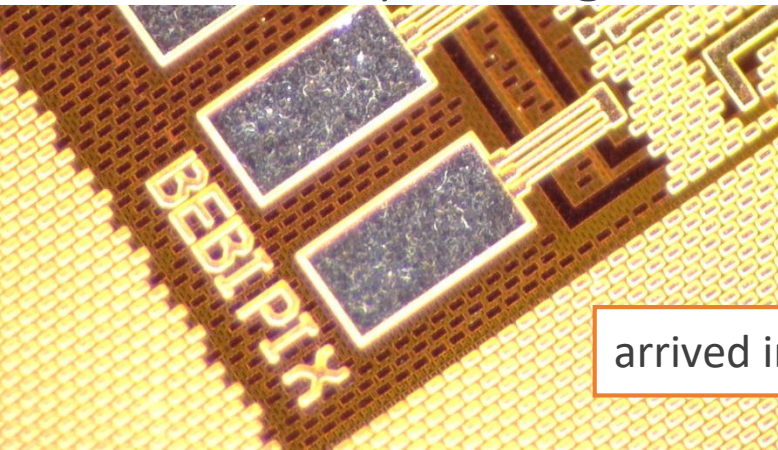
🔗 ASIC for the FASER experiment: S. Gonzalez-Sevilla, doi: 10.1088/1748-0221/18/02/C02002

- 🔗 first test looking good

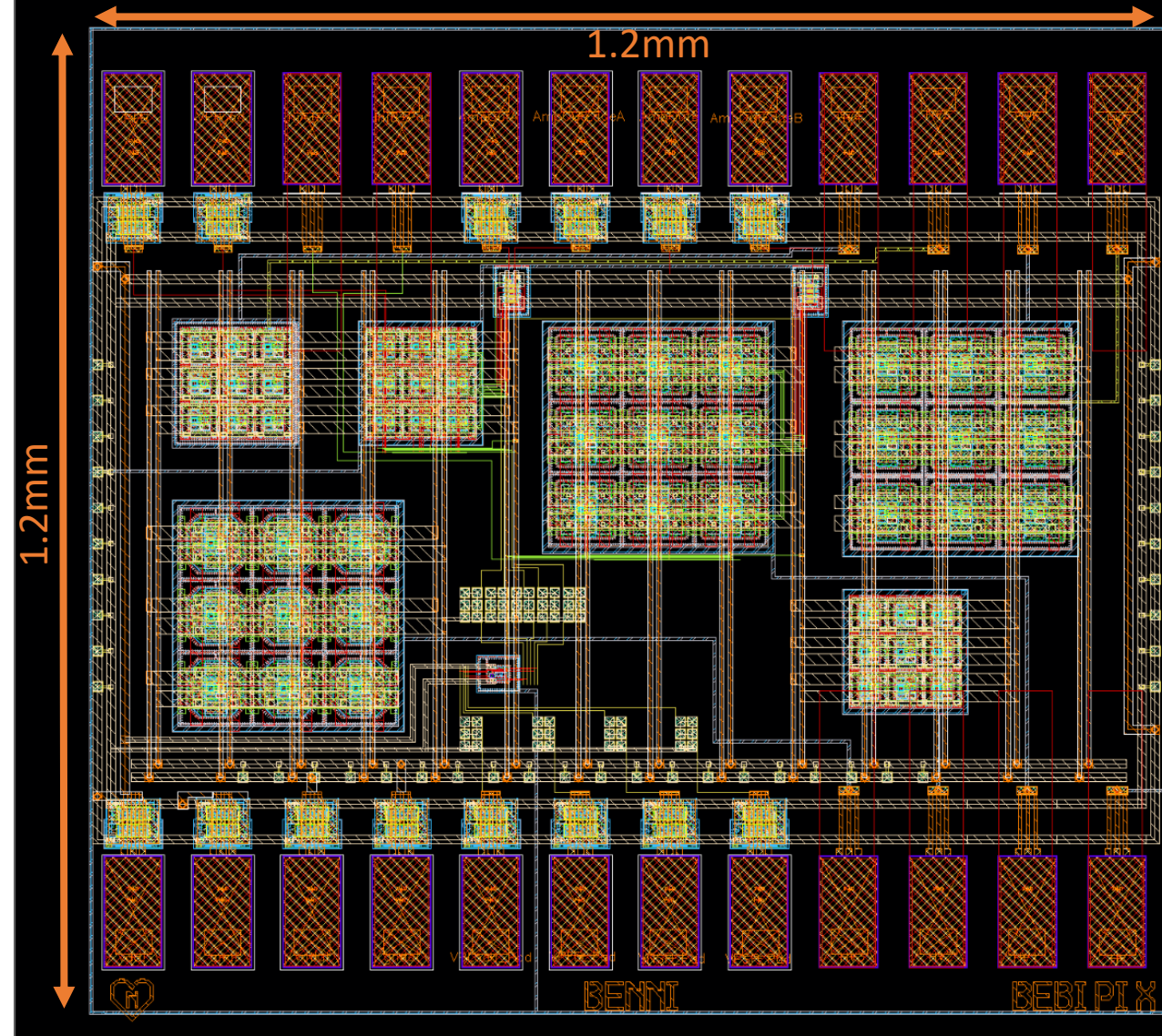
- 🔗 no results for the time resolution published yet

BeBiPix

- small test chip produced in the BiCMOS Process SG13G2 by IHP
- 2 active 3×3 pixel matrices, characterised in simulations
- focusing on a small pixel layout with in-pixel amplifier
- fully analog read-out

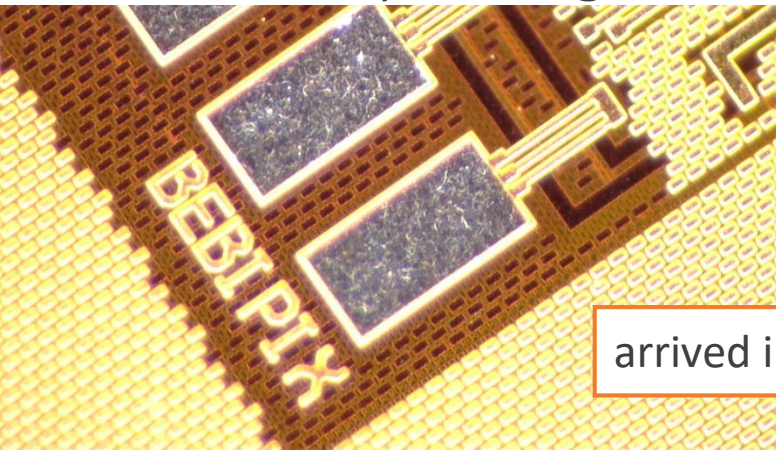


arrived in summer 2022

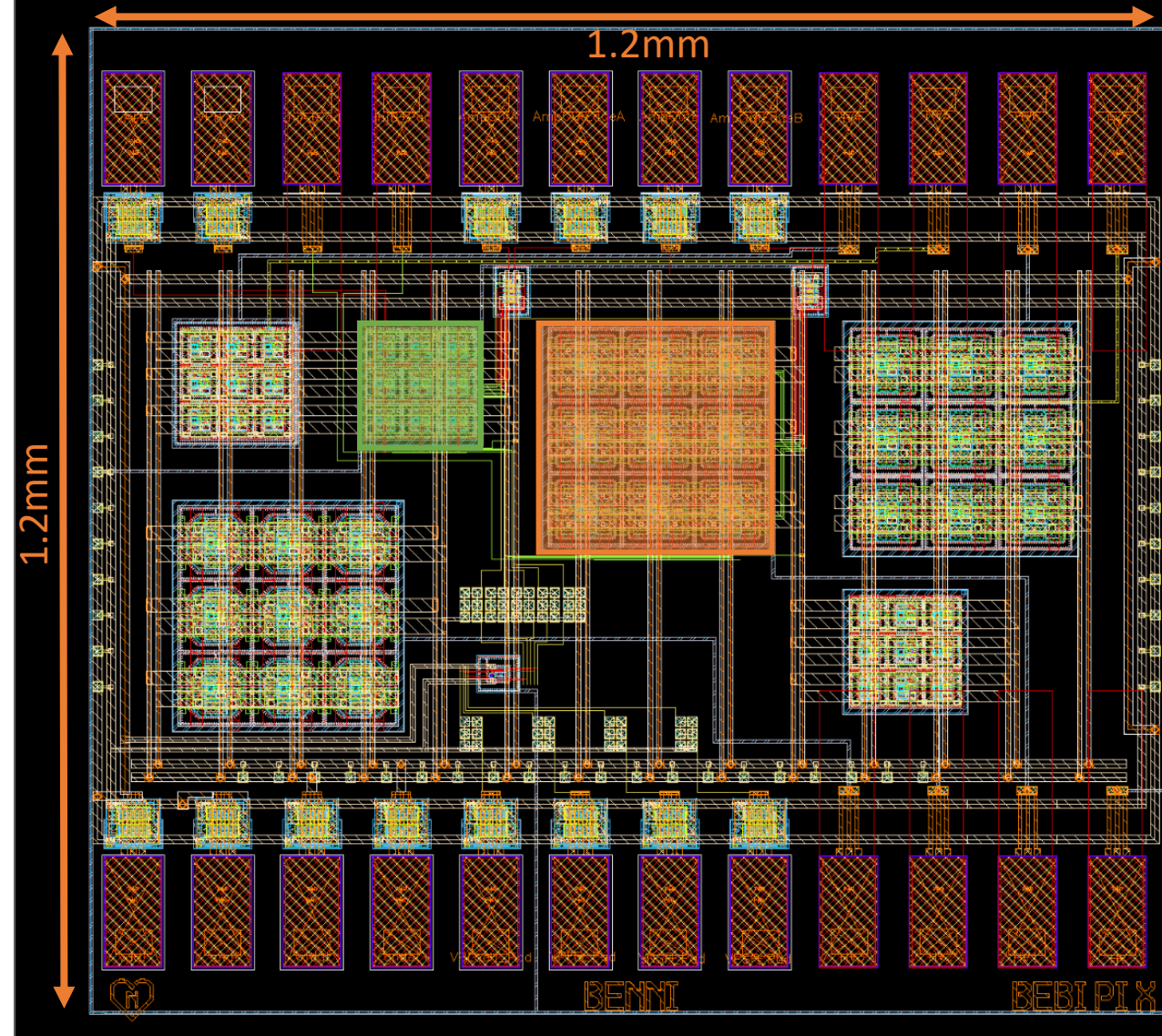


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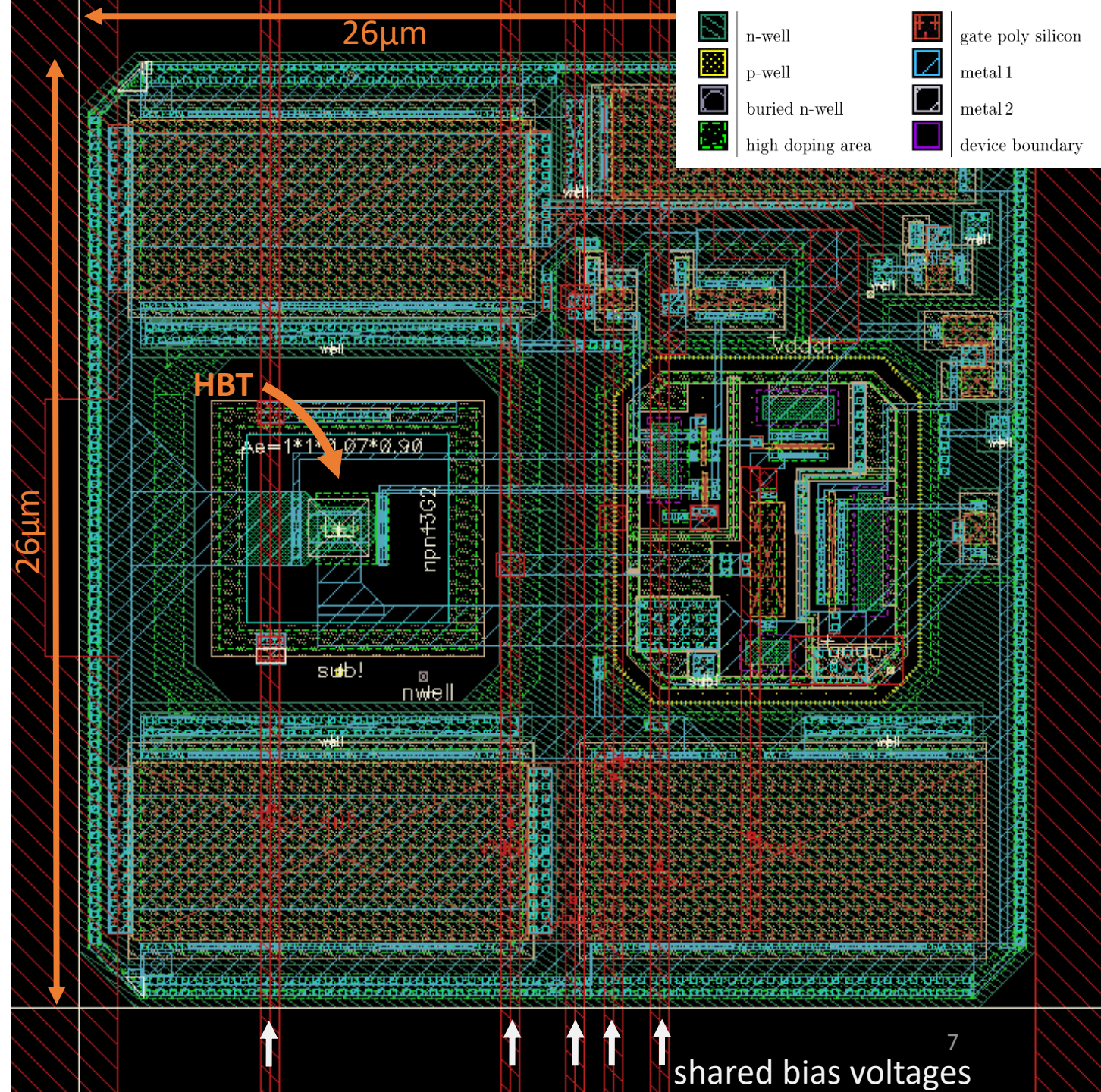
Small Pixel Layout

- implant size $26 \times 26 \mu\text{m}^2$
- pixel size $41 \times 41 \mu\text{m}^2$

Simulation results:

- input signal corresponding $\approx 2800 e^-$

Amplitude	$149.8 \pm 3.1 \text{ mV}$
Rise Time	$741 \pm 340 \text{ ps}$
SNR	27 ± 3.9
ToA Jitter	$481 \pm 33 \text{ ps}$



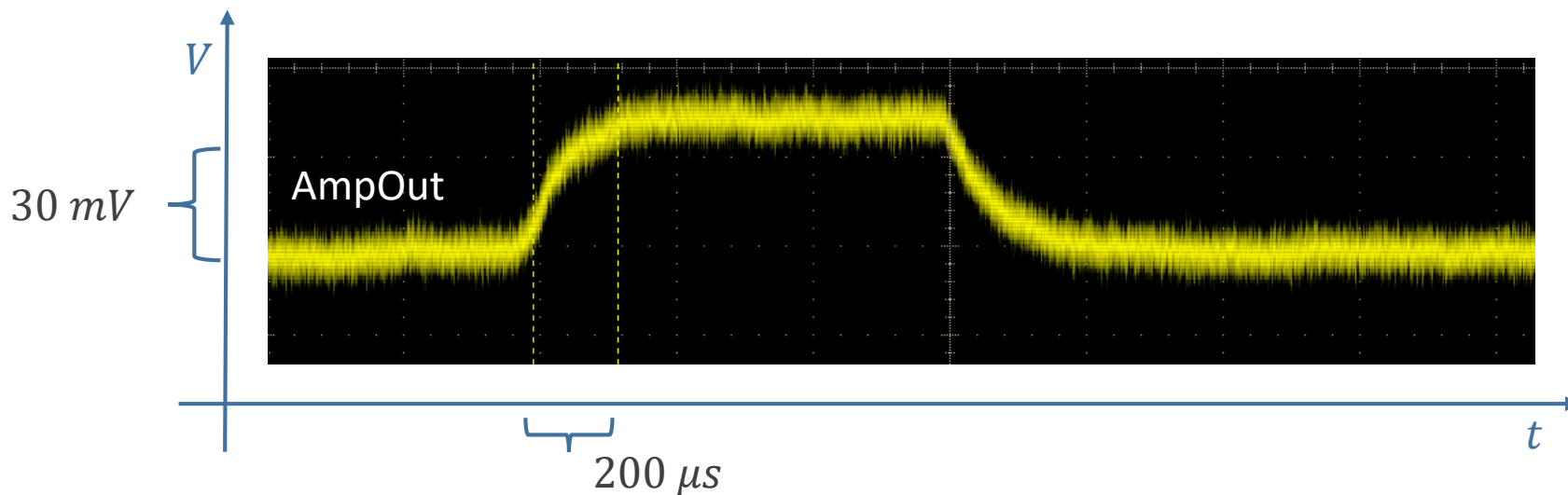
...However

Problem 1: early breakdown

- expected $BDV \approx 90\text{ V}$ from TCad simulation
- measured $BDV \approx 10\text{ V}$

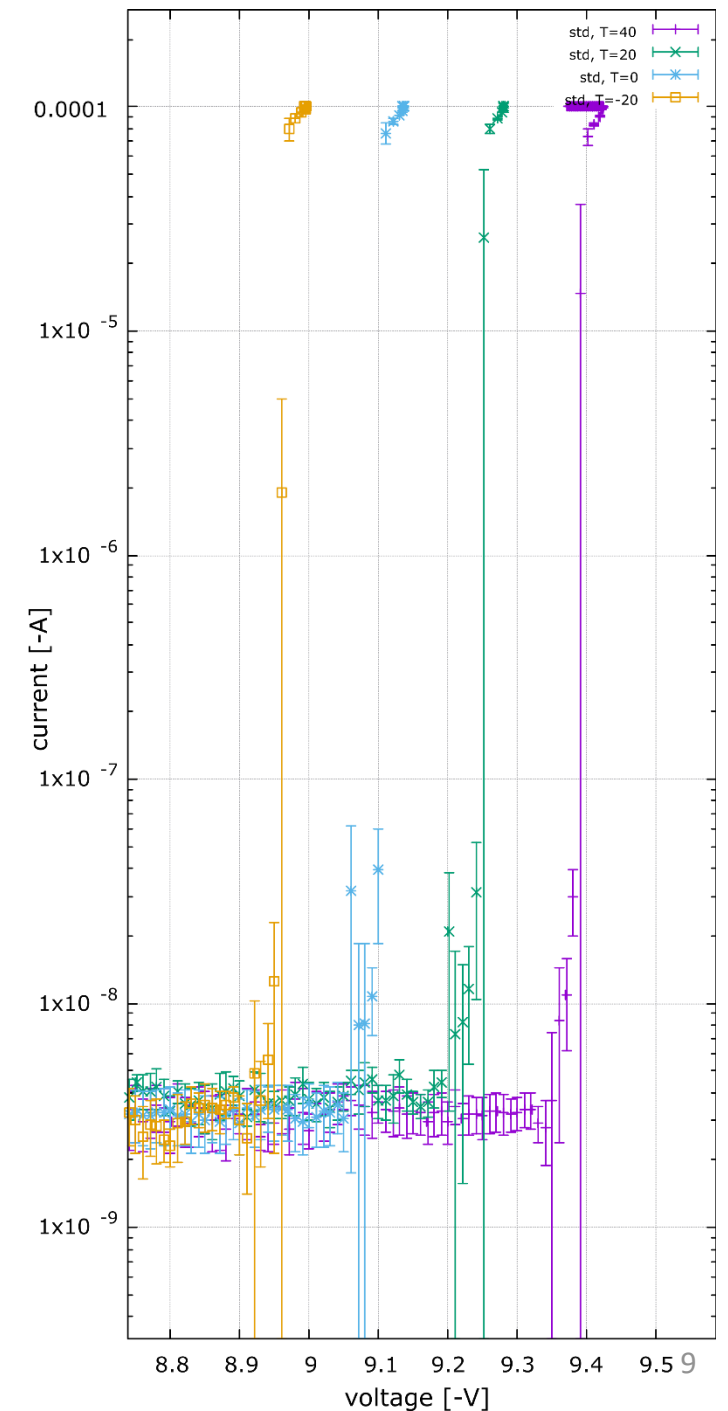
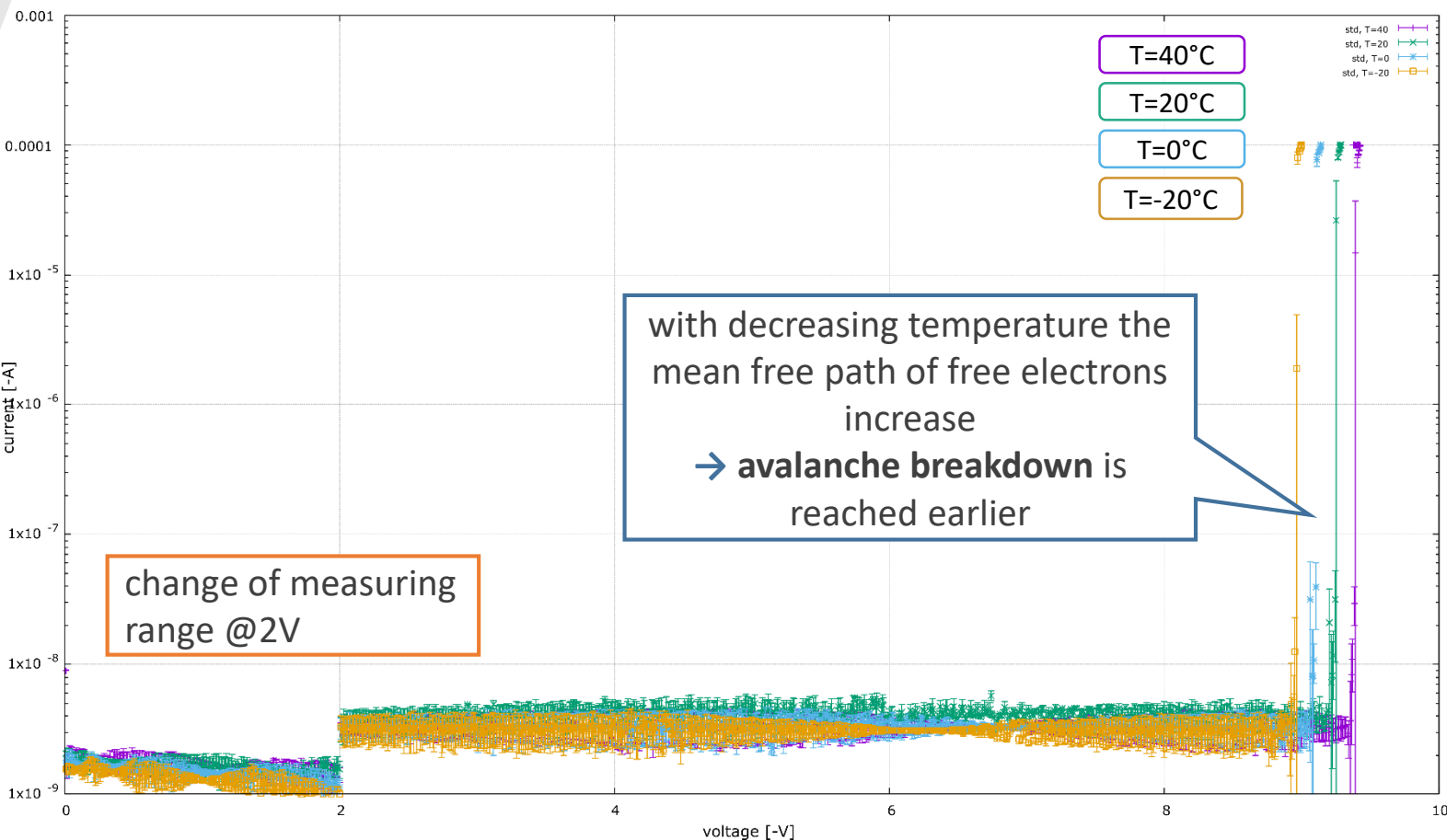
Problem 2: poorly functioning amplifier feedback

- only slow and large input signals (from red laser) are visible



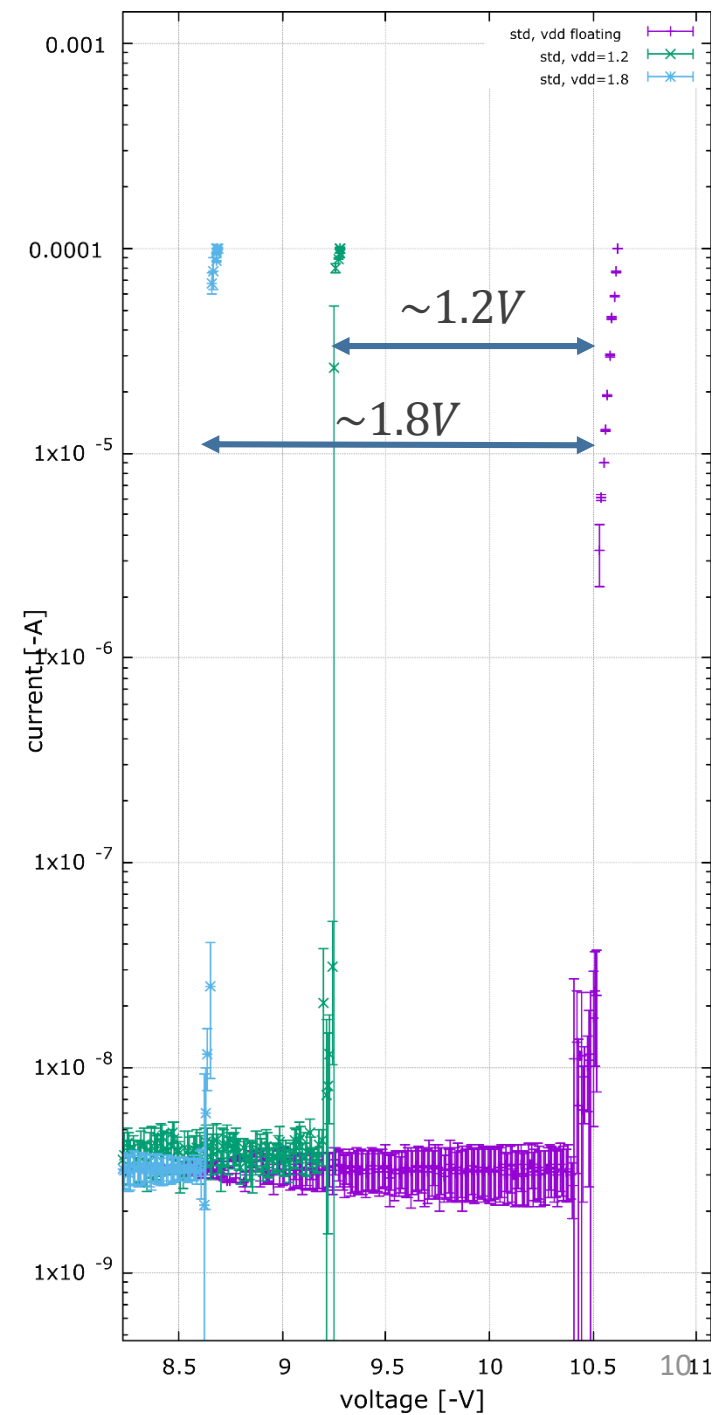
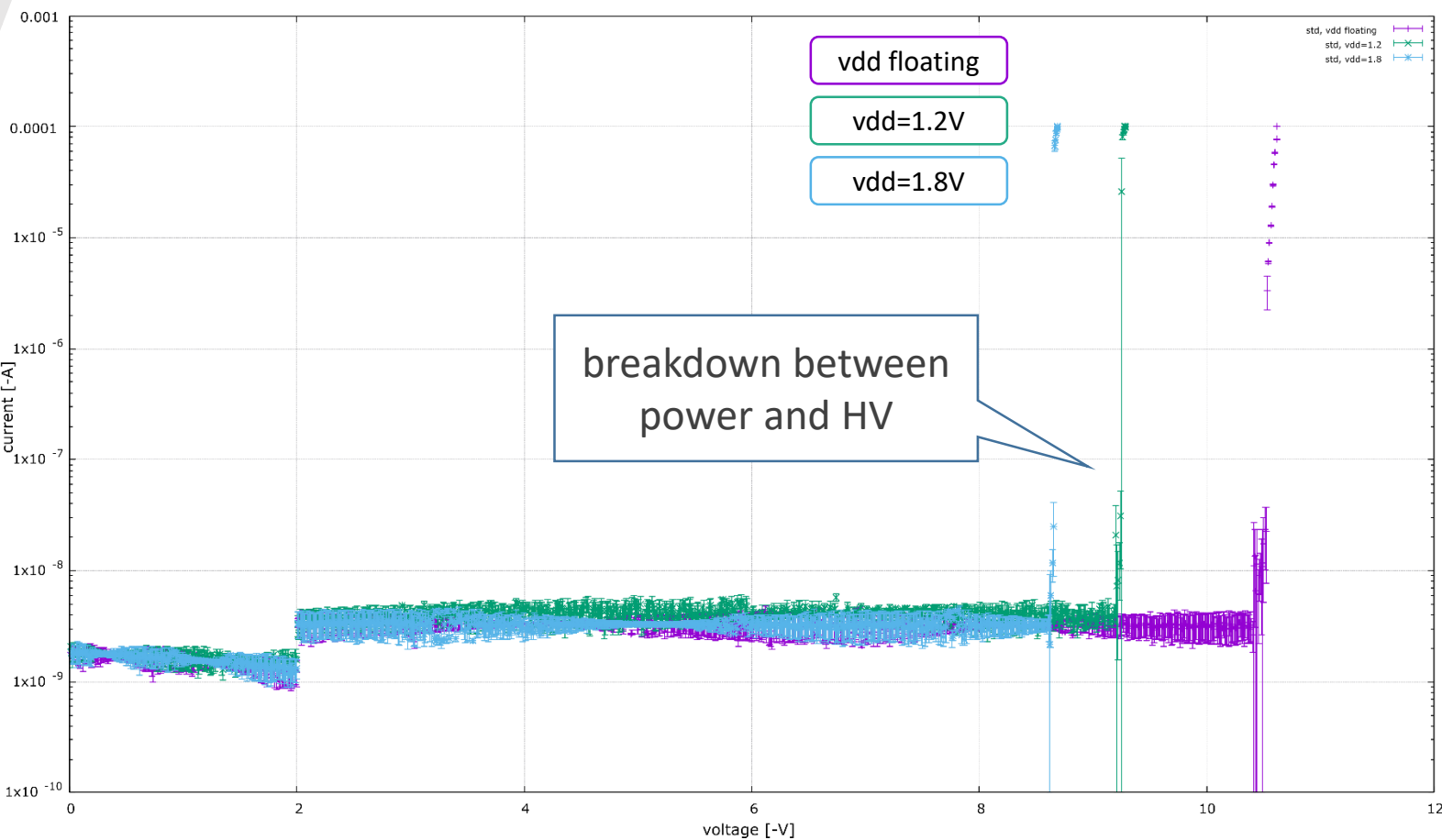
Investigation of the Breakdown

🔑 dependency on temperature



Investigation of the Breakdown

🔗 dependency on vdd-voltage (vdda floating)





Investigation of Breakdown

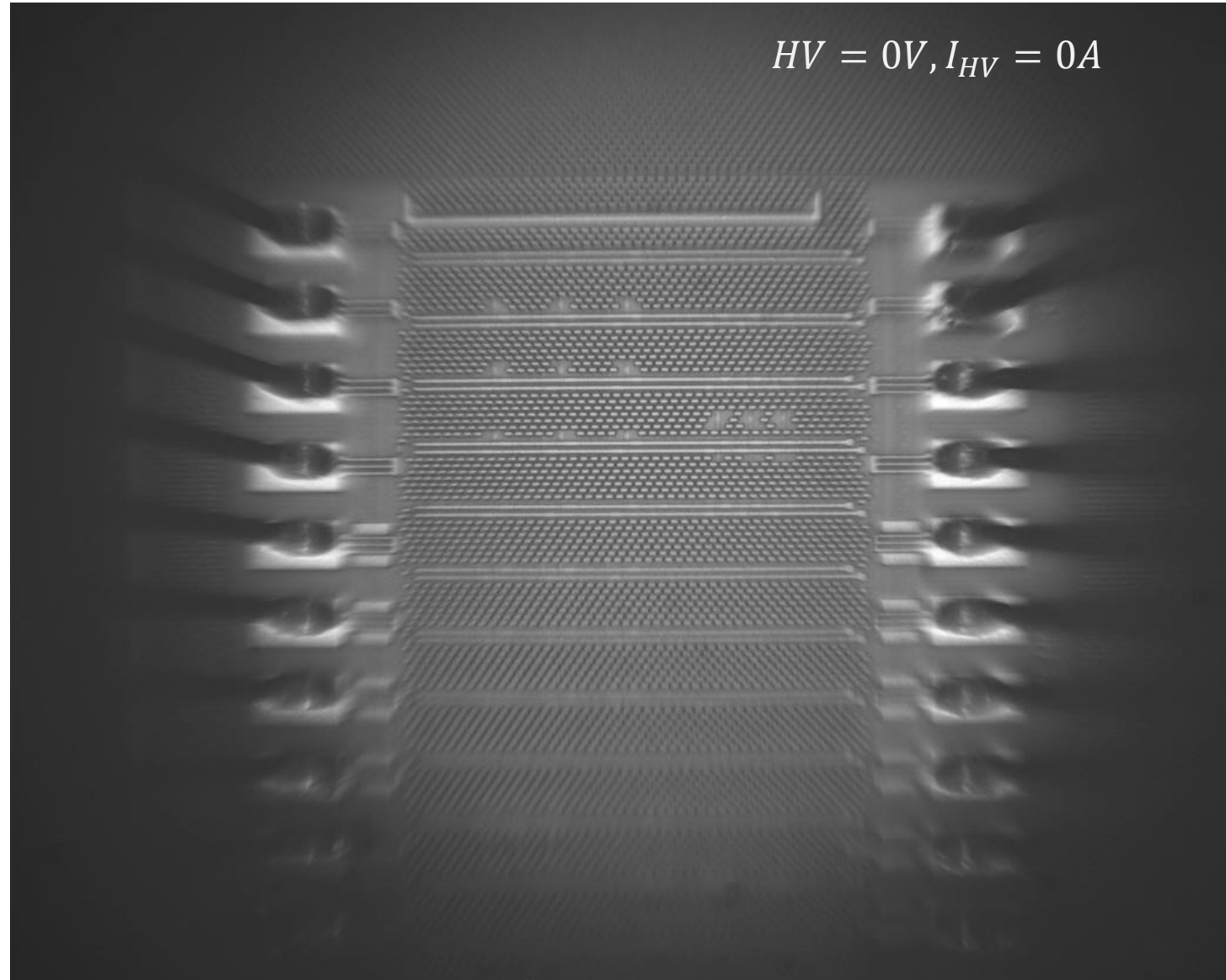
Light Emission Test (LET)

- pn-junctions at avalanche breakdown emits light
 - Intra-band transitions → mostly Bremsstrahlung
 - Inter-band transitions → e-h pair recombination
- light is emitted from localized spots, with highest electrical field
 - increasing current results in an increasing number of spots

→ use CCD camera in light-tight box to capture emission
→ light spots indicate position of the breakdown

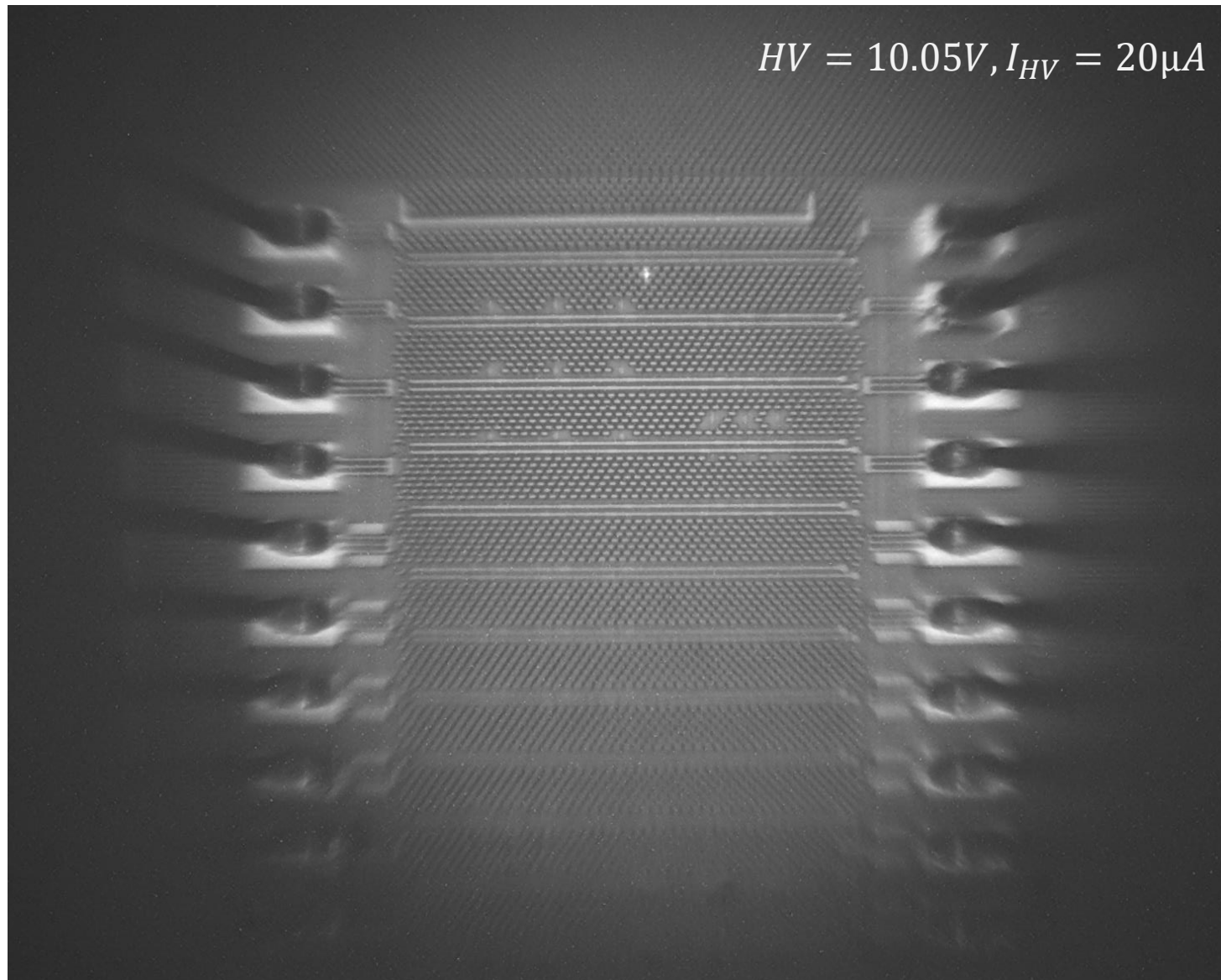
LET Measurement

- exposure of a part of the BeBiPix
- sensor breakdown: $BDV \approx 10.1\text{ V}$
- LED is used to illuminate the sensor



LET Measurement

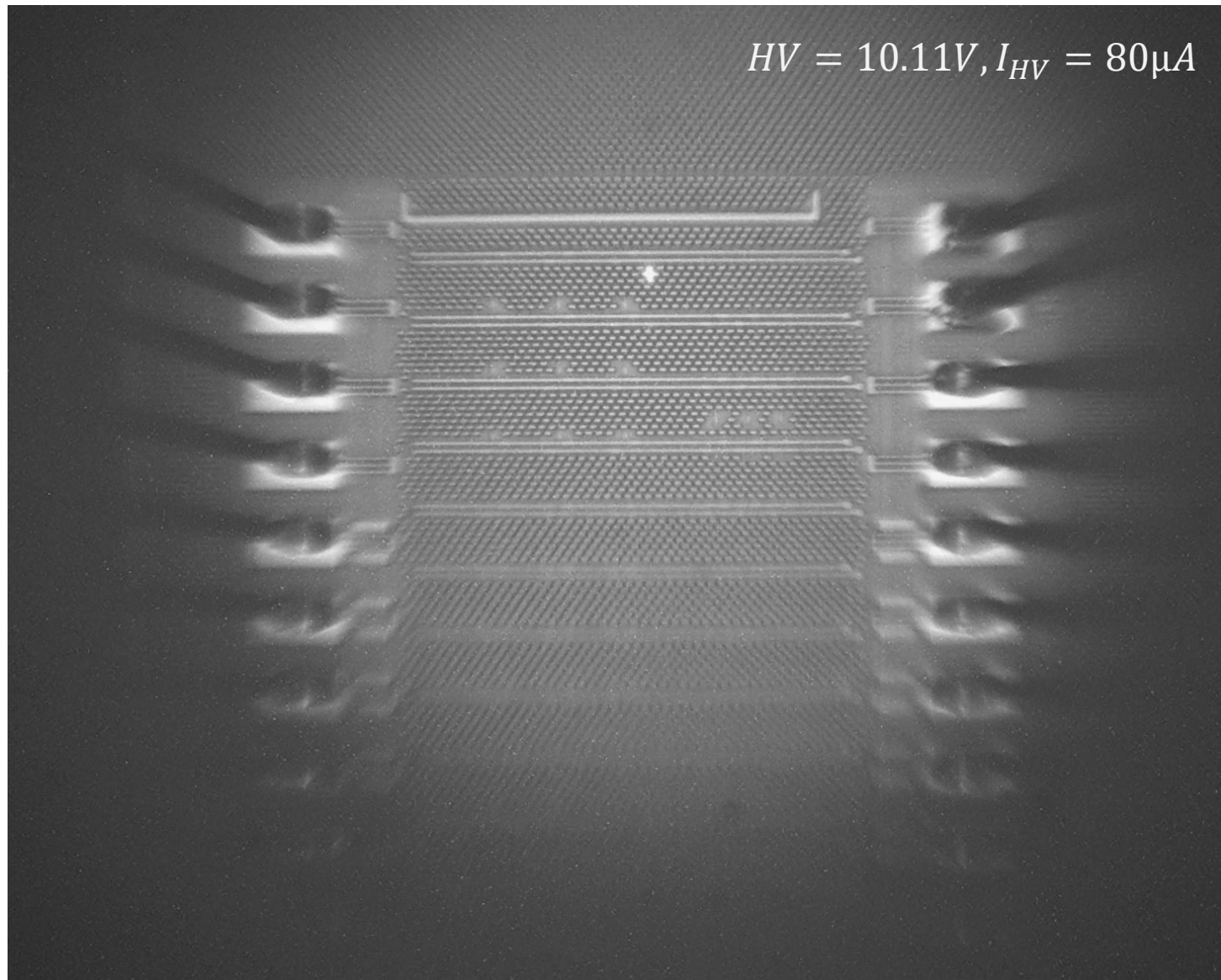
$HV = 10.05V, I_{HV} = 20\mu A$



- exposure of a part of the BeBiPix
- sensor breakdown: $BDV \approx 10.1 V$
- LED is used to illuminate the sensor
- 10min exposurer

LET Measurement

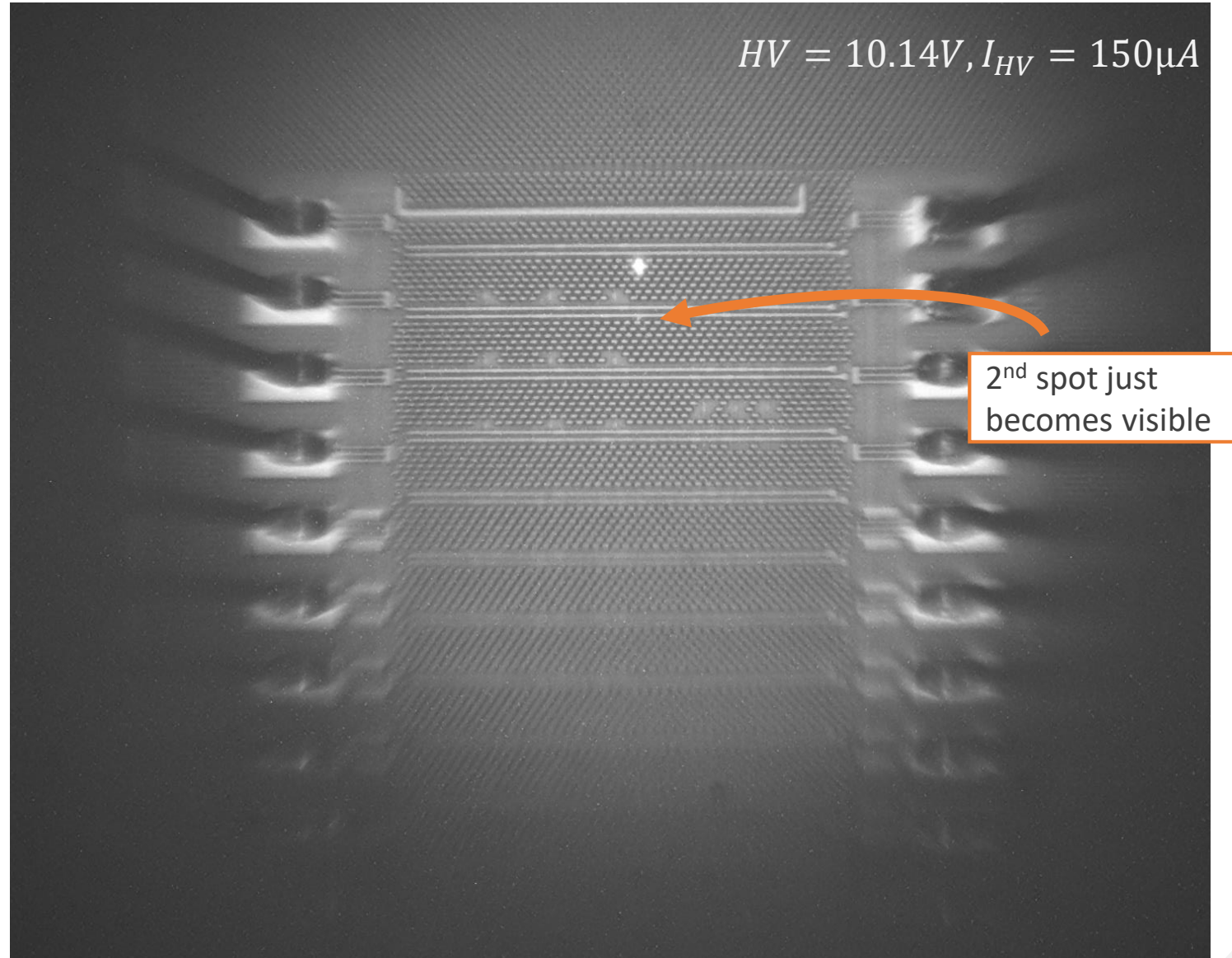
$HV = 10.11V, I_{HV} = 80\mu A$



- exposure of a part of the BeBiPix
- sensor breakdown: $BDV \approx 10.1 V$
- LED is used to illuminate the sensor
- 10min exposurer

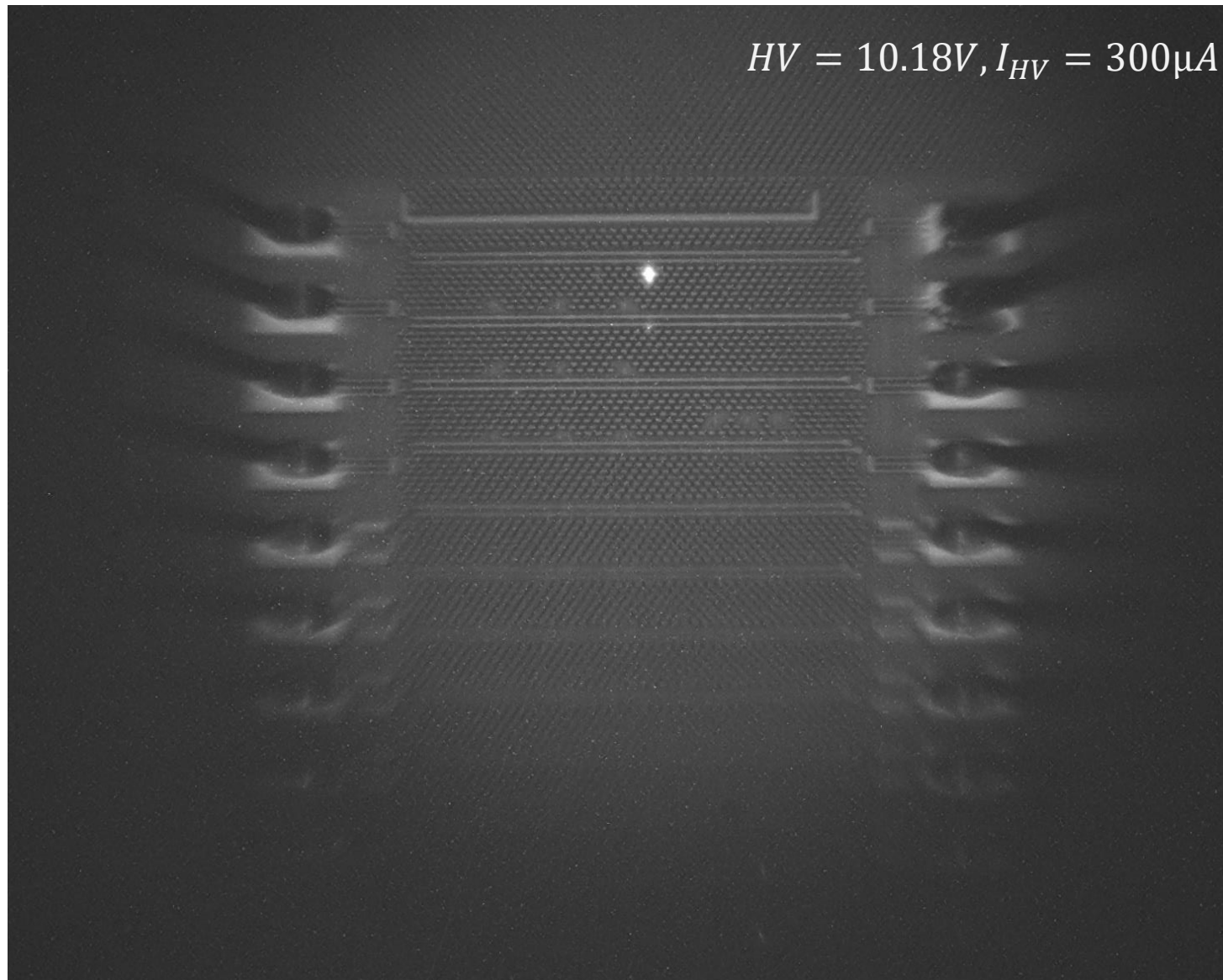
LET Measurement

- exposure of a part of the BeBiPix
- sensor breakdown: $BDV \approx 10.1\text{ V}$
- LED is used to illuminate the sensor
- 10min exposurer



LET Measurement

$HV = 10.18V, I_{HV} = 300\mu A$



- exposure of a part of the BeBiPix
- sensor breakdown: $BDV \approx 10.1 V$
- dim LED
- 10min exposurer

LET Measurement

$HV = 10.18V, I_{HV} = 300\mu A$

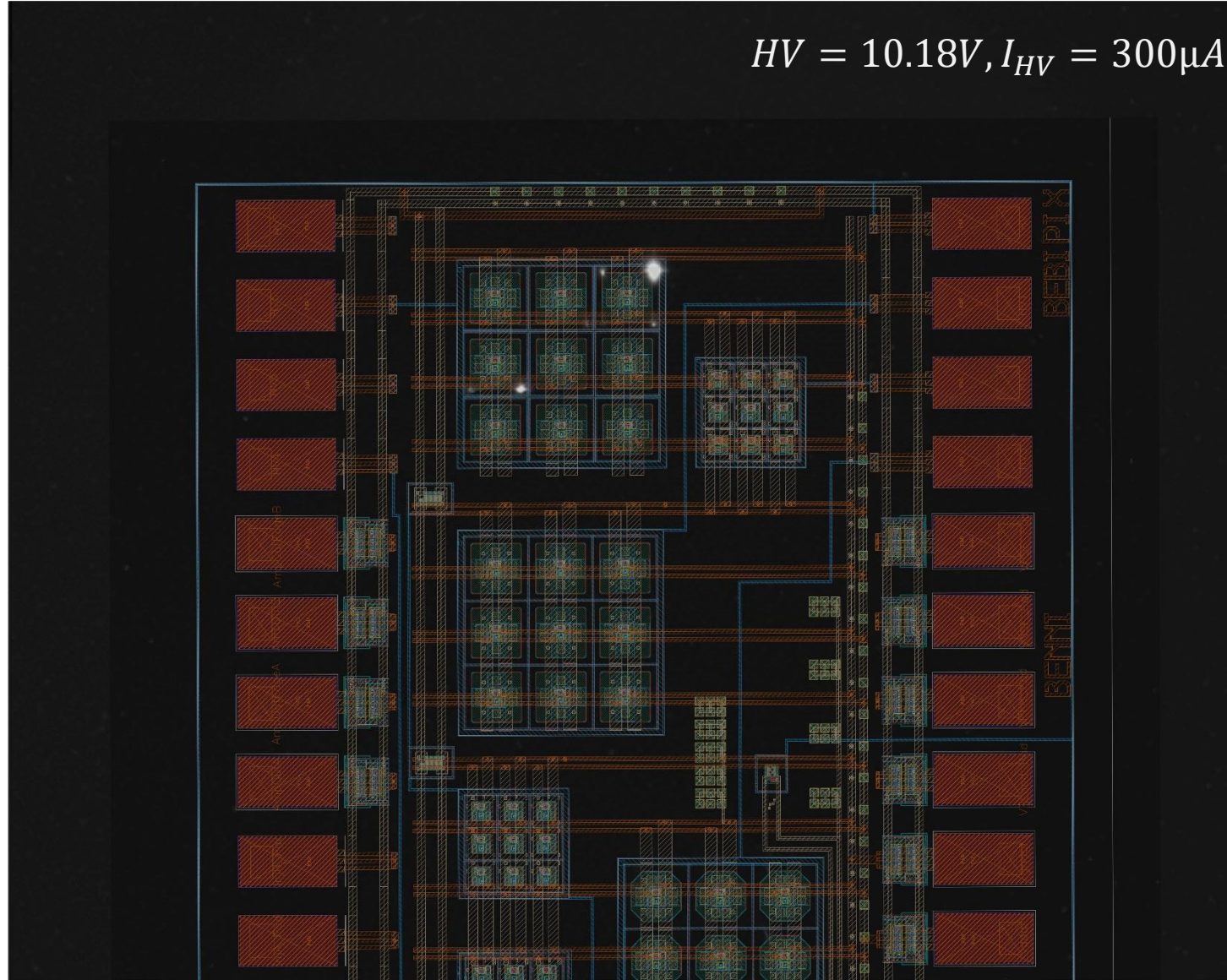


- exposure of a part of the BeBiPix
- sensor breakdown: $BDV \approx 10.1 V$
- without LED
- 30min exposure

LET Measurement

$$HV = 10.18V, I_{HV} = 300\mu A$$

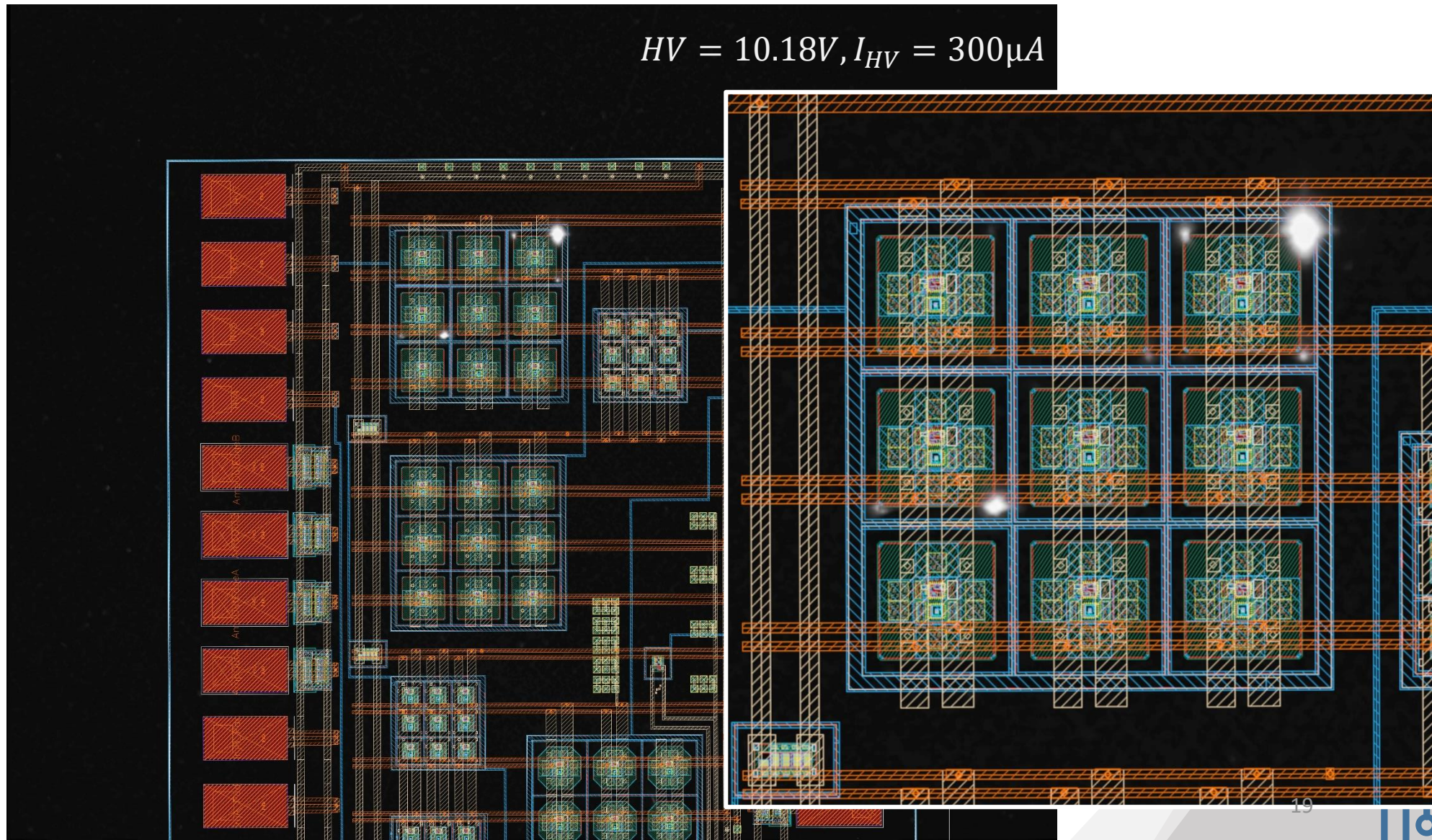
- exposure of a part of the BeBiPix
- sensor breakdown: $BDV \approx 10.1V$
- overlay layout



LET Measurement

$$HV = 10.18V, I_{HV} = 300\mu A$$

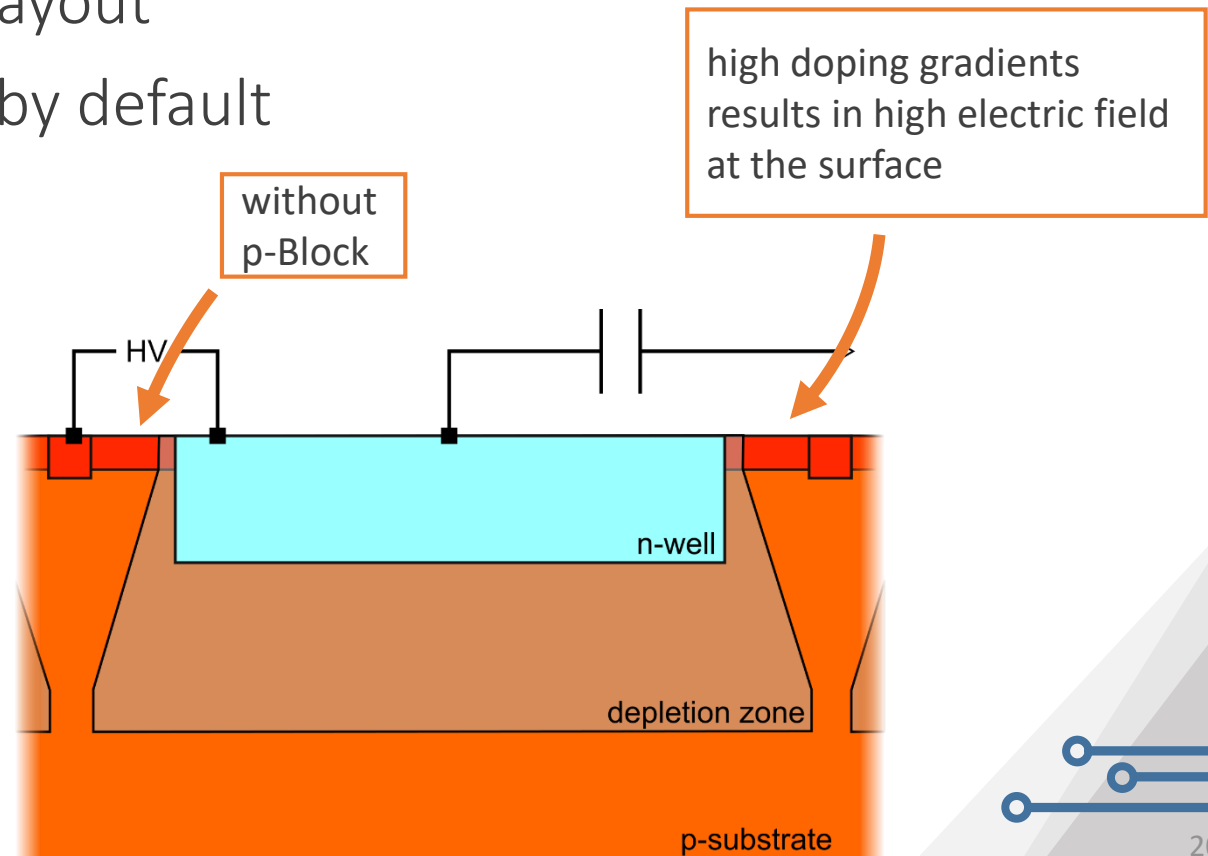
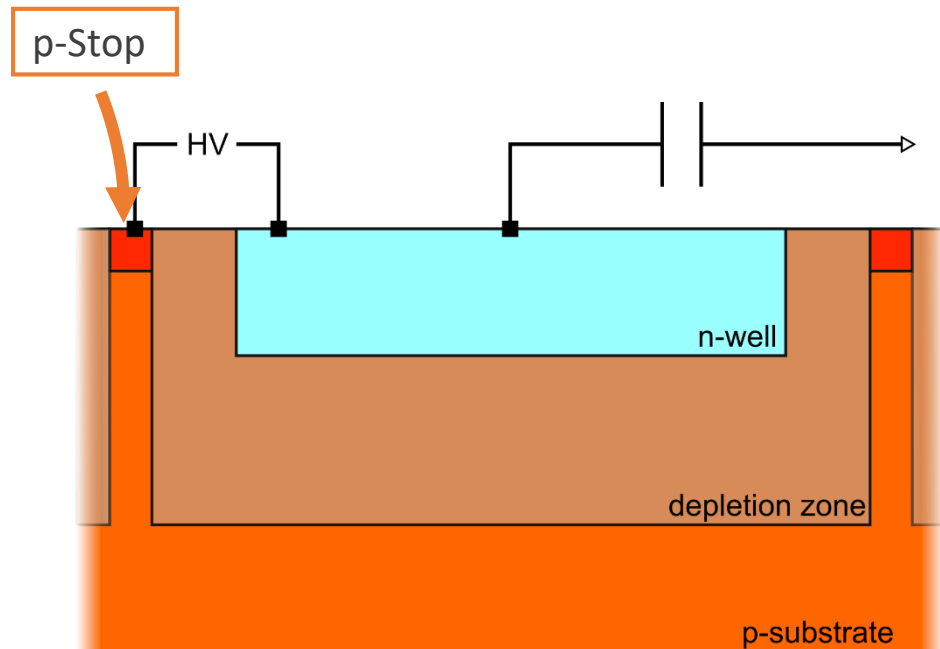
- exposure of a part of the BeBiPix
- sensor breakdown: $BDV \approx 10.1V$
- overlay layout



Early Breakdown

Most possible reason:

- ❏ p-Block layer was forgotten in layout
- ❏ manufacturer places p-doping by default





Summary

- combination of a BiCMOS Process with HV-MAPS is a promising concept
 - simulation showed good results for the timing
- BeBiPix has still several problems:
 - early breakdown
 - poorly functioning amplifier-feedback: only slow signals visible
- next steps:
 - use TCT-setup to investigate Signal response further